

**REF1004**

## 1.2V and 2.5V Micropower VOLTAGE REFERENCE

### FEATURES

- **INITIAL ACCURACY:**  
REF1004-1.2  $\pm 4\text{mV}$   
REF1004-2.5  $\pm 20\text{mV}$
- **MINIMUM OPERATING CURRENT:**  
REF1004-1.2  $10\mu\text{A}$   
REF1004-2.5  $20\mu\text{A}$
- **EXCELLENT LONG TERM TEMPERATURE STABILITY**
- **VERY LOW DYNAMIC IMPEDANCE**
- **OPERATES UP TO 20mA**
- **PACKAGE: 8-Lead SOIC**

### APPLICATIONS

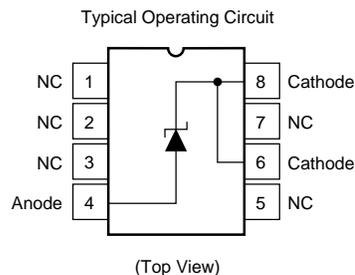
- **BATTERY POWERED TEST EQUIPMENT**
- **PORTABLE MEDICAL INSTRUMENTATION**
- **PORTABLE COMMUNICATIONS DEVICES**
- **A/D AND D/A CONVERTERS**
- **NOTEBOOK AND PALMTOP COMPUTERS**

### DESCRIPTION

The REF1004-1.2 and REF1004-2.5 are two terminal bandgap reference diodes designed for high accuracy with outstanding temperature characteristics at low operating currents. Prior to the introduction of the REF1004 Micropower Voltage References, accuracy and stability specifications could only be attained by expensive screening of standard devices. The REF1004 is a cost effective solution when reference voltage accuracy, low power, and long term temperature stability are required.

REF1004 is a drop-in replacement for the LT1004 as well as an upgraded replacement of the LM185/385 series references. The REF1004C is characterized for operation from  $0^{\circ}\text{C}$  to  $70^{\circ}\text{C}$  and the REF1004I is characterized for operation from  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ .

The REF1004 is offered in an 8-lead Plastic SOIC package and shipped in anti-static rails or tape and reel.



International Airport Industrial Park • Mailing Address: PO Box 11400 • Tucson, AZ 85734 • Street Address: 6730 S. Tucson Blvd. • Tucson, AZ 85706  
Tel: (520) 746-1111 • Twx: 910-952-1111 • Cable: BBRCORP • Telex: 066-6491 • FAX: (520) 889-1510 • Immediate Product Info: (800) 548-6132

# SPECIFICATIONS

## ELECTRICAL

T<sub>A</sub> = +25°C unless otherwise noted.

| PARAMETER   | CONDITIONS   | REF1004-1.2             |                         |  | REF1004-2.5             |                         |  | UNITS   |
|---|--|-------------------------|-------------------------|--|-------------------------|-------------------------|--|---------|
|   |  | MIN                     | TYP                     | MAX  | MIN                     | TYP                     | MAX  |         |
| REFERENCE VOLTAGE<br>REF1004C <sup>(1)</sup><br>REF1004I <sup>(2)</sup> | I <sub>R</sub> = 100μA   | 1.231<br>1.229<br>1.225 | 1.235<br>1.235<br>1.235 | 1.239<br>1.239<br>1.239                            | 2.490<br>2.487<br>2.480 | 2.500<br>2.500<br>2.500 | 2.511<br>2.511<br>2.511                            | V       |
| AVERAGE TEMPERATURE COEFFICIENT   | I <sub>MIN</sub> ≤ I <sub>R</sub> ≤ 20mA                               |                         | 20                      |  |                         | 20                      |  | ppm/°C  |
| MINIMUM OPERATION CURRENT <sup>(3)</sup>                                |  |                         | 8                       | 10   |                         | 12                      | 20   | μA      |
| REVERSE BREAKDOWN VOLTAGE CHANGE WITH CURRENT                           | I <sub>MIN</sub> ≤ I <sub>R</sub> ≤ 1mA<br>1mA ≤ I <sub>R</sub> ≤ 20mA |                         |                         | 1<br>1.5 <sup>(3)</sup><br>10<br>20 <sup>(3)</sup> |                         |                         | 1<br>1.5 <sup>(3)</sup><br>10<br>20 <sup>(3)</sup> | mV      |
| REVERSE DYNAMIC IMPEDANCE <sup>(3)</sup>                                | I <sub>R</sub> = 100μA   |                         | 0.2                     | 0.6  |                         | 0.2                     | 0.6  | Ω       |
| WIDE BAND NOISE (RMS)<br>10Hz ≤ I <sub>R</sub> ≤ 10kHz                  | I <sub>R</sub> = 100μA   |                         | 60                      |  |                         | 120                     |  | μV      |
| LONG TERM STABILITY<br>T <sub>A</sub> = 25°C ± 0.1°C                    | I <sub>R</sub> = 100μA   |                         | 20                      |  |                         | 20                      |  | ppm/KHr |

NOTES: (1) This specification applies over the full operating temperature range of 0°C ≤ T<sub>A</sub> ≤ 70°C. (2) This specification applies over the full operating temperature range of 40°C ≤ T<sub>A</sub> ≤ +85°C. (3) Denotes the specifications which apply over the full operating temperature range.

## ORDERING INFORMATION

| MODEL        | T <sub>A</sub> | V <sub>Z</sub> | PACKAGE     |
|--------------|----------------|----------------|-------------|
| REF1004C-1.2 | 0°C to +70°C   | 1.2V           | 8-Lead SOIC |
| REF1004C-2.5 | 0°C to +70°C   | 2.5V           | 8-Lead SOIC |
| REF1004I-1.2 | -40°C to +85°C | 1.2V           | 8-Lead SOIC |
| REF1004I-2.5 | -40°C to +85°C | 2.5V           | 8-Lead SOIC |

NOTE: Available in Tape and Reel, Add -TR to Model Number.

## ABSOLUTE MAXIMUM RATINGS

|   |                 |
|---|-----------------|
| Reverse Breakdown Current .....         | 30mA            |
| Forward Current .....                   | 10mA            |
| Operating Temperature Range             |                 |
| REF1004C .....                          | 0°C to +70°C    |
| REF1004I .....                          | -40°C to +85°C  |
| Storage Temperature                     |                 |
| REF1004C .....                          | -65°C to +150°C |
| REF1004I .....                          | -65°C to +150°C |
| Lead Temperature (soldering, 10s) ..... | +300°C          |

## ORDERING INFORMATION

| MODEL        | PART MARKING |
|--------------|--------------|
| REF1004C-1.2 | BBREF0412    |
| REF1004C-2.5 | BBREF0425    |
| REF1004I-1.2 | BBREF0412    |
| REF1004I-2.5 | BBREF0425    |

## PACKAGE INFORMATION

| MODEL        | PACKAGE    | PACKAGE DRAWING NUMBER <sup>(1)</sup> |
|--------------|------------|---------------------------------------|
| REF1004C-1.2 | 8-Pin SOIC | 182                                   |
| REF1004C-2.5 | 8-Pin SOIC | 182                                   |
| REF1004I-1.2 | 8-Pin SOIC | 182                                   |
| REF1004I-2.5 | 8-Pin SOIC | 182                                   |

NOTE: (1) For detailed drawing and dimension table, please see end of data sheet, or Appendix D of Burr-Brown IC Data Book.

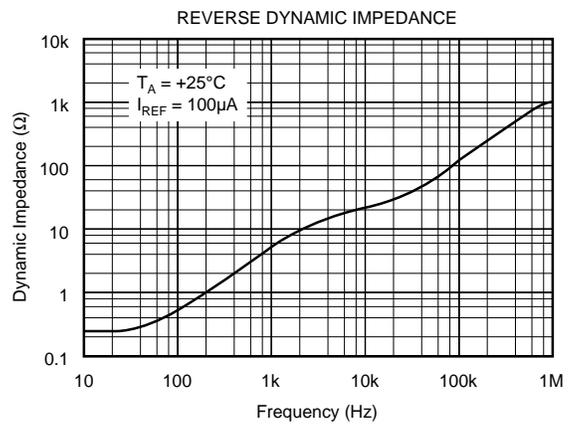
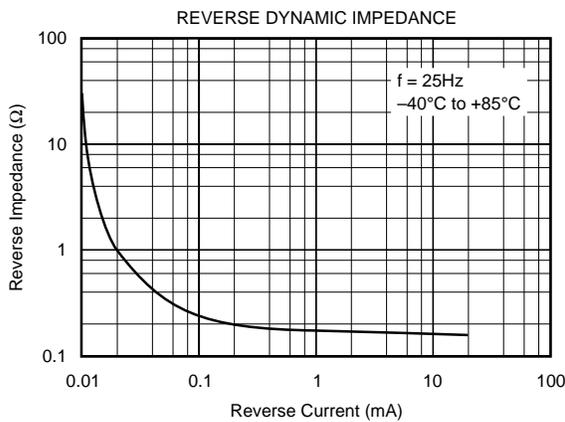
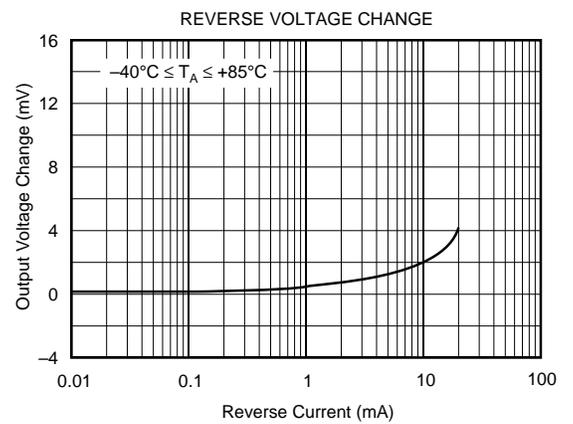
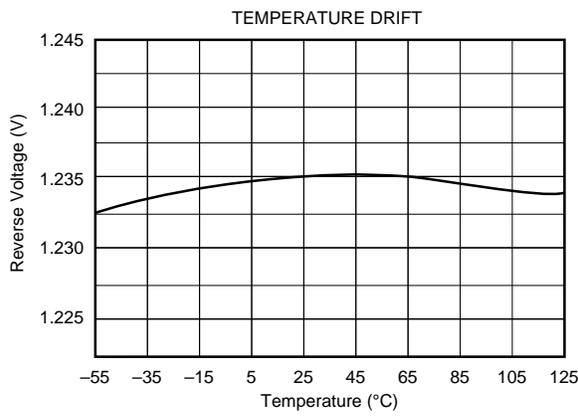
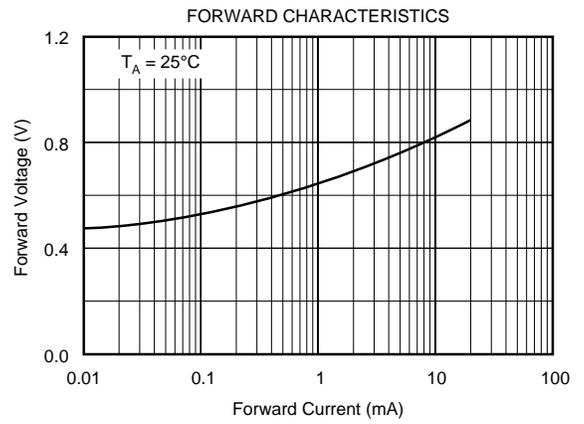
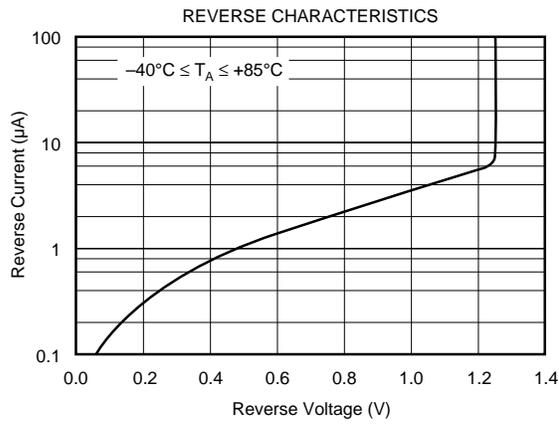
The information provided herein is believed to be reliable; however, BURR-BROWN assumes no responsibility for inaccuracies or omissions. BURR-BROWN assumes no responsibility for the use of this information, and all use of such information shall be entirely at the user's own risk. Prices and specifications are subject to change without notice. No patent rights or licenses to any of the circuits described herein are implied or granted to any third party. BURR-BROWN does not authorize or warrant any BURR-BROWN product for use in life support devices and/or systems.



REF1004

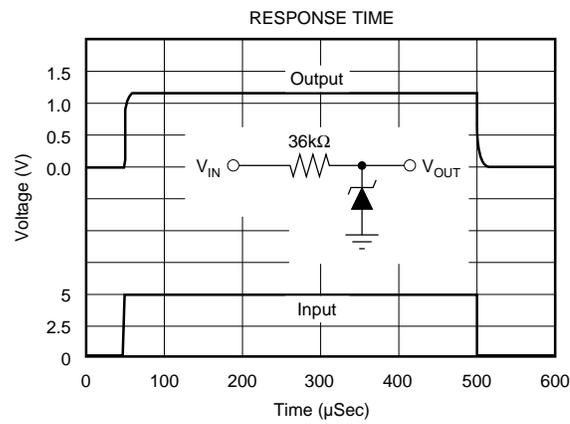
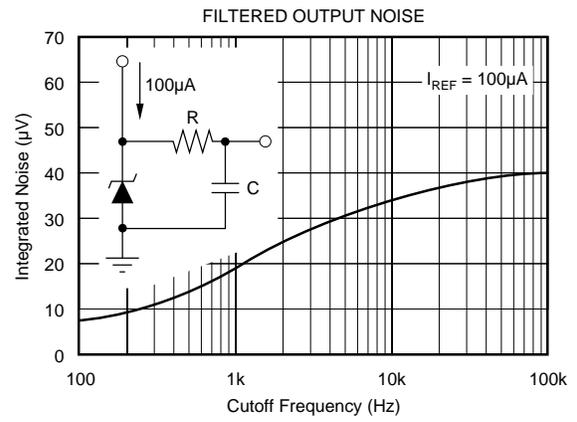
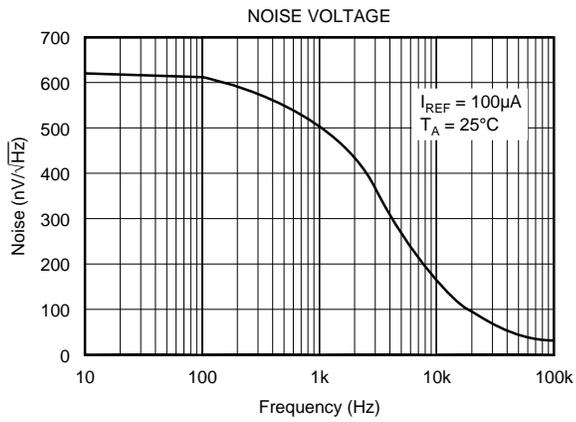
# TYPICAL PERFORMANCE CURVES 1.2V

$T_A = +25^\circ\text{C}$  unless otherwise noted.



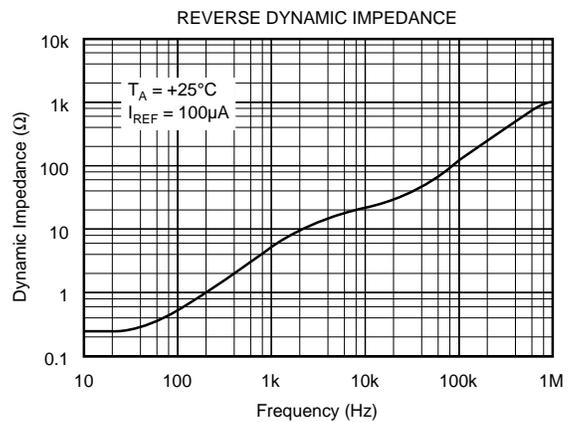
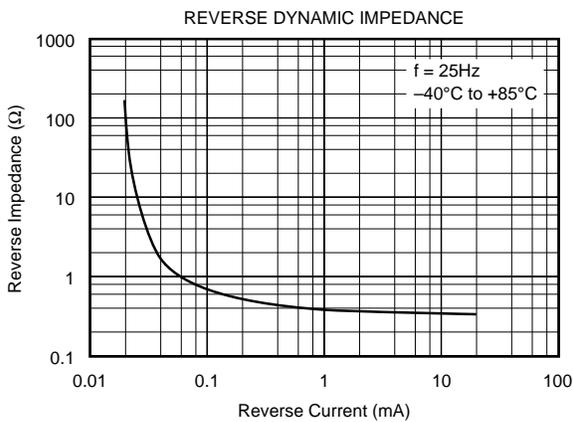
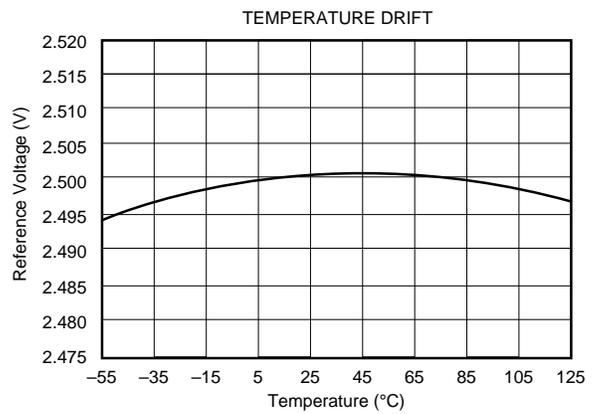
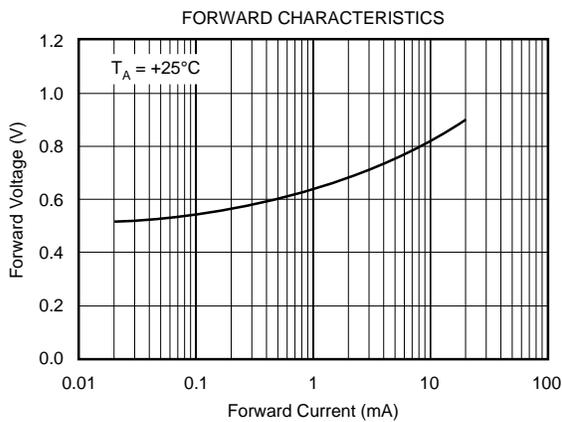
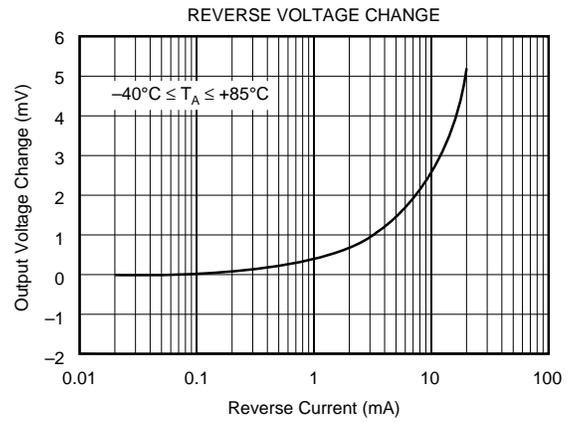
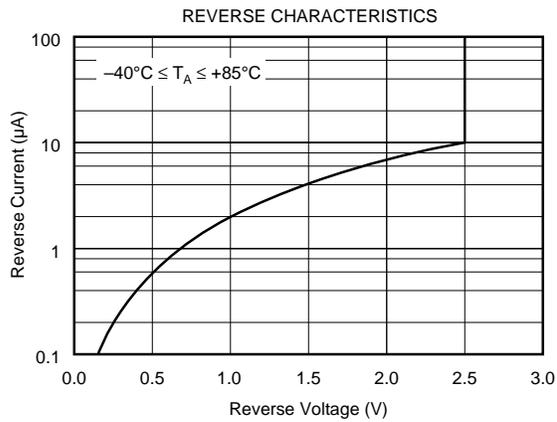
# TYPICAL PERFORMANCE CURVES 1.2V (CONT)

$T_A = +25^\circ\text{C}$  unless otherwise noted.



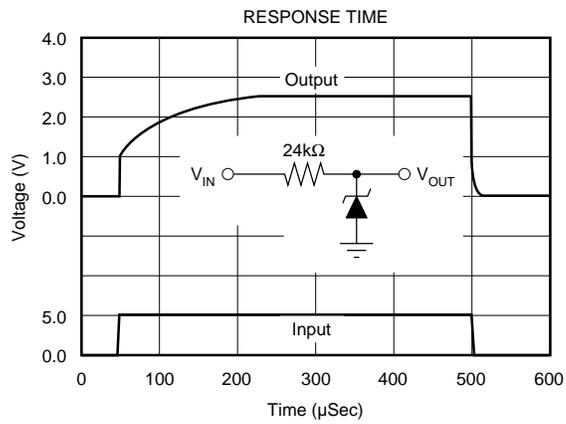
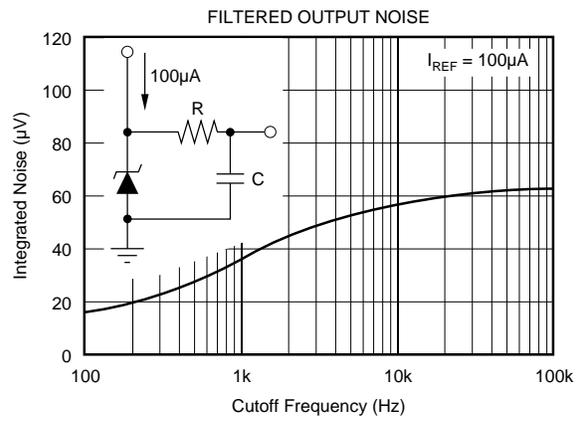
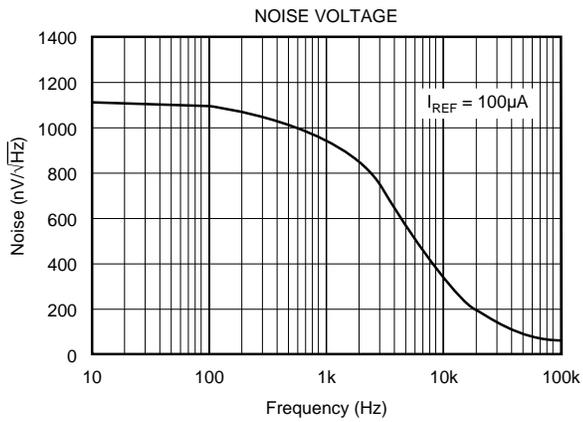
# TYPICAL PERFORMANCE CURVES 2.5V

$T_A = +25^\circ\text{C}$  unless otherwise noted.



# TYPICAL PERFORMANCE CURVES 2.5V (CONT)

T<sub>A</sub> = +25°C unless otherwise noted.



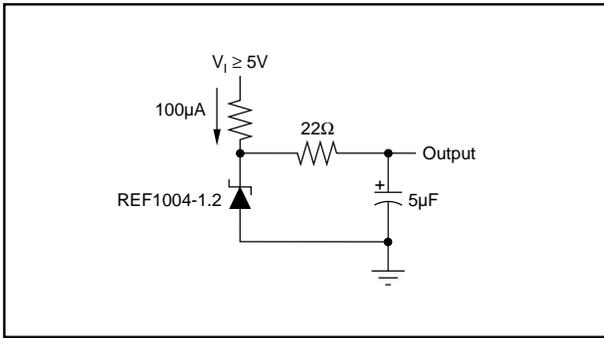


FIGURE 1. Low-Noise Reference.

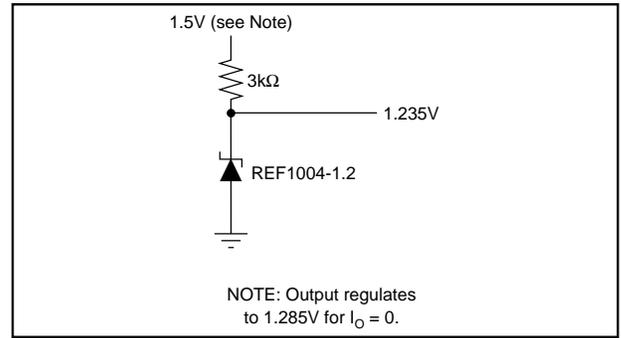


FIGURE 3. 1.2V Reference from 1.5V Battery.

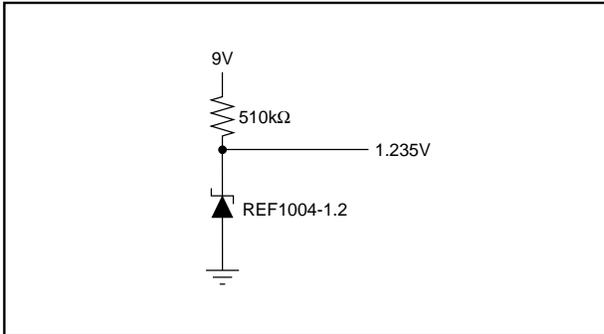


FIGURE 2. Micropower Reference from 9V Battery.

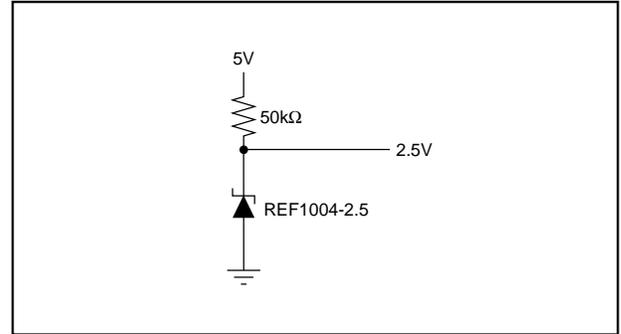


FIGURE 4. 2.5V Reference.

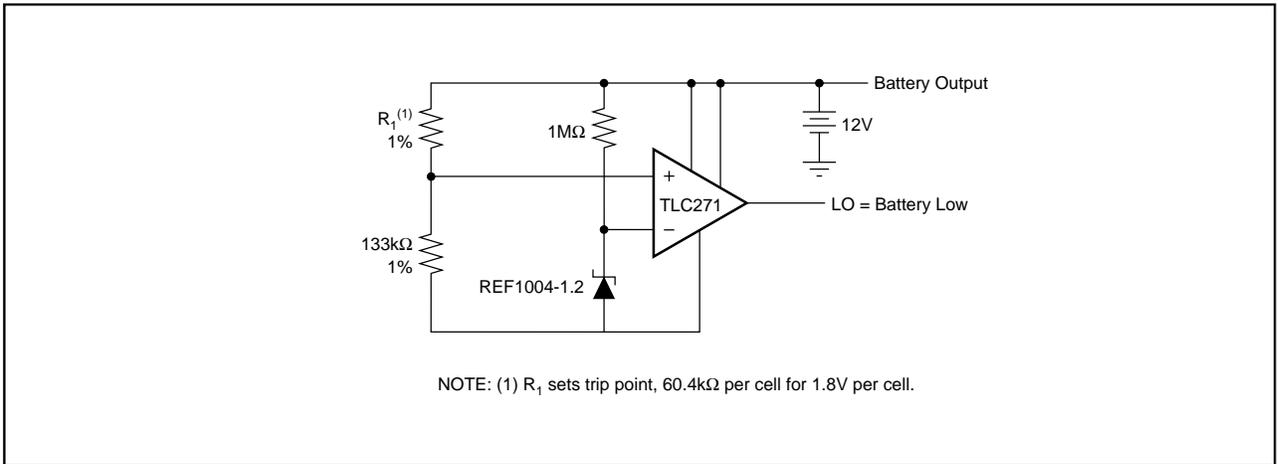


FIGURE 5. Lead-Acid Low-Battery-Voltage Detector.

**PACKAGING INFORMATION**

| Orderable Device   | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|--------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| REF1004C-1.2       | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| REF1004C-1.2/2K5   | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| REF1004C-1.2/2K5E4 | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| REF1004C-1.2E4     | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| REF1004C-2.5       | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| REF1004C-2.5/2K5   | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| REF1004C-2.5/2K5E4 | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| REF1004C-2.5E4     | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| REF1004I-1.2       | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| REF1004I-1.2/2K5   | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| REF1004I-1.2/2K5E4 | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| REF1004I-1.2E4     | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| REF1004I-2.5       | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| REF1004I-2.5/2K5   | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| REF1004I-2.5/2K5E4 | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| REF1004I-2.5E4     | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSELETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

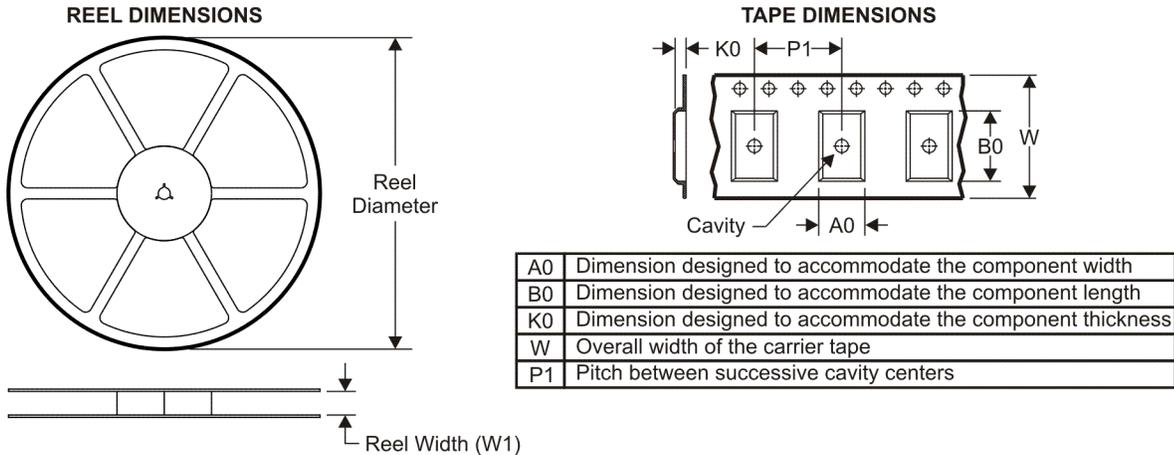
**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

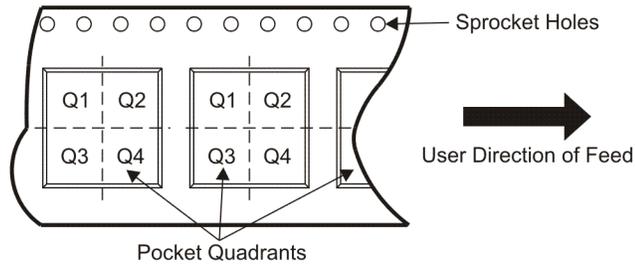
**Important Information and Disclaimer:**The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**TAPE AND REEL INFORMATION**



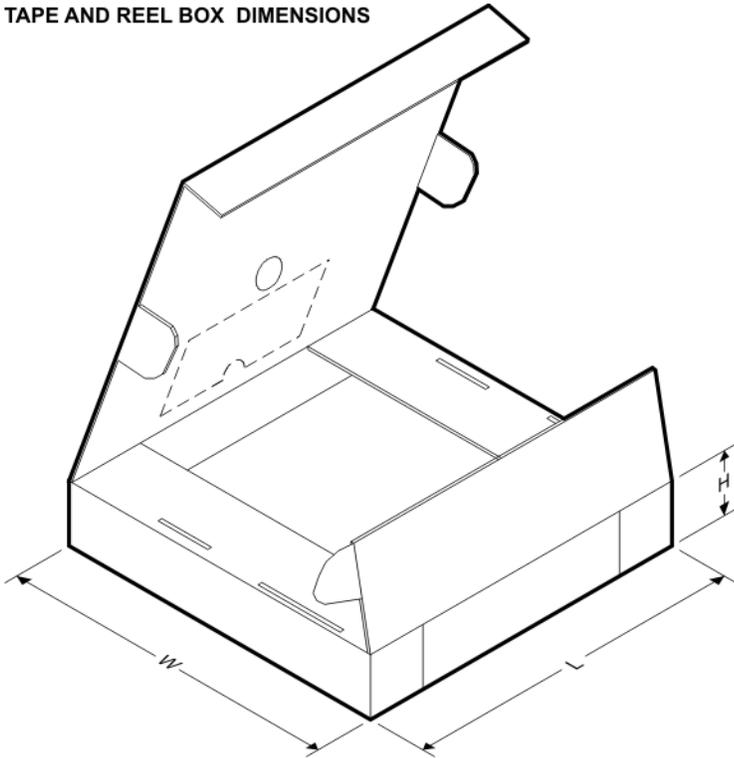
**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**



\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| REF1004C-1.2/2K5 | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF1004C-2.5/2K5 | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF1004I-1.2/2K5 | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| REF1004I-2.5/2K5 | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |

**TAPE AND REEL BOX DIMENSIONS**



\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| REF1004C-1.2/2K5 | SOIC         | D               | 8    | 2500 | 346.0       | 346.0      | 29.0        |
| REF1004C-2.5/2K5 | SOIC         | D               | 8    | 2500 | 346.0       | 346.0      | 29.0        |
| REF1004I-1.2/2K5 | SOIC         | D               | 8    | 2500 | 346.0       | 346.0      | 29.0        |
| REF1004I-2.5/2K5 | SOIC         | D               | 8    | 2500 | 346.0       | 346.0      | 29.0        |

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

### Products

|                             |  |
|-----------------------------|--|
| Amplifiers                  | <a href="http://amplifier.ti.com">amplifier.ti.com</a>             |
| Data Converters             | <a href="http://dataconverter.ti.com">dataconverter.ti.com</a>     |
| DSP                         | <a href="http://dsp.ti.com">dsp.ti.com</a>                         |
| Clocks and Timers           | <a href="http://www.ti.com/clocks">www.ti.com/clocks</a>           |
| Interface                   | <a href="http://interface.ti.com">interface.ti.com</a>             |
| Logic                       | <a href="http://logic.ti.com">logic.ti.com</a>                     |
| Power Mgmt                  | <a href="http://power.ti.com">power.ti.com</a>                     |
| Microcontrollers            | <a href="http://microcontroller.ti.com">microcontroller.ti.com</a> |
| RFID                        | <a href="http://www.ti-rfid.com">www.ti-rfid.com</a>               |
| RF/IF and ZigBee® Solutions | <a href="http://www.ti.com/lprf">www.ti.com/lprf</a>               |

### Applications

|                    |  |
|--------------------|--|
| Audio              | <a href="http://www.ti.com/audio">www.ti.com/audio</a>                   |
| Automotive         | <a href="http://www.ti.com/automotive">www.ti.com/automotive</a>         |
| Broadband          | <a href="http://www.ti.com/broadband">www.ti.com/broadband</a>           |
| Digital Control    | <a href="http://www.ti.com/digitalcontrol">www.ti.com/digitalcontrol</a> |
| Medical            | <a href="http://www.ti.com/medical">www.ti.com/medical</a>               |
| Military           | <a href="http://www.ti.com/military">www.ti.com/military</a>             |
| Optical Networking | <a href="http://www.ti.com/opticalnetwork">www.ti.com/opticalnetwork</a> |
| Security           | <a href="http://www.ti.com/security">www.ti.com/security</a>             |
| Telephony          | <a href="http://www.ti.com/telephony">www.ti.com/telephony</a>           |
| Video & Imaging    | <a href="http://www.ti.com/video">www.ti.com/video</a>                   |
| Wireless           | <a href="http://www.ti.com/wireless">www.ti.com/wireless</a>             |

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
Copyright © 2008, Texas Instruments Incorporated

# AMEYA360

## Components Supply Platform

Authorized Distribution Brand :



Website :

Welcome to visit [www.ameya360.com](http://www.ameya360.com)

Contact Us :

➤ Address :

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd  
Minhang District, Shanghai , China

➤ Sales :

Direct +86 (21) 6401-6692

Email [amall@ameya360.com](mailto:amall@ameya360.com)

QQ 800077892

Skype [ameyasales1](#) [ameyasales2](#)

➤ Customer Service :

Email [service@ameya360.com](mailto:service@ameya360.com)

➤ Partnership :

Tel +86 (21) 64016692-8333

Email [mkt@ameya360.com](mailto:mkt@ameya360.com)